

Product Change Notification

Issue Date: 11th May, 2021
Ref. Number: PCN-20210511-007

Subject	SIM7600E-H1C add alternative baseband chip & PAs	
Current	Baseband chip	PAs
	Qualcomm MDM9607-0	Airoha AP7215M-41 Airoha AP6712M-21
Alternative	Baseband chip	PAs
	Qualcomm MDM9207-0	SMARTERMICRO S5643-51 SMARTERMICRO S2916-51
Classification	☐ Design Change ☐ Manufacturing process/ method ☐ Manufacturing condition ☐ Manufacturing location ☐ Material ☐ Others	
Effective Date	11 th May, 2021	

Reason/s for Change

Because the baseband chip & PAs used in SIM7600E-H1C have a long lead time, SIMCom has to add alternative ones as second source. The current ones and the alternative ones are all listed in above table. SIMCom declares that this change will not affect the customer applications. In order to distinguish the modules which use alternative baseband chip & PAs, we add some new P/Ns to these modules.

Please note:

Module name	Current P/N	Alternative P/N
SIM7600E-H1C	S2-108MQ	S2-10A9B
SIM7600E-H1C-PCIE	S2-10974	S2-10AF4

Thanks for choosing SIMCom products!

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11th May, 2021